

## General Description

The HM60N75K uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

## Product Summary

|                   |      |    |
|-------------------|------|----|
| $BV_{DSS}$ typ.   | 84   | V  |
| $R_{DS(ON)}$ typ. | 6.8  | mΩ |
|                   | max. | mΩ |
| $I_D$             | 60   | A  |

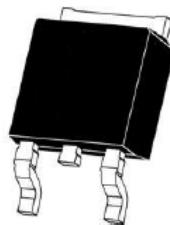
## Features

- $V_{DS}=75V$ ;  $I_D=60A$  @  $V_{GS}=10V$ ;  
 $R_{DS(ON)}<8.5m\Omega$  @  $V_{GS}=10V$
- Special process technology for high ESD capability
- Special designed for Convertors and power controls
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high  $E_{AS}$
- Excellent package for good heat dissipation

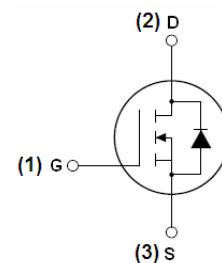
## Application

- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

100% UIS TESTED!



TO-252-2L top view



Schematic diagram

## Package Marking and Ordering Information

| Device Marking | Device   | Device Package | Reel Size | Tape width | Quantity |
|----------------|----------|----------------|-----------|------------|----------|
| HM60N75K       | HM60N75K | TO-252-2L      | -         | -          | -        |

Table 1. Absolute Maximum Ratings ( $T_c=25^\circ C$ )

| Parameter   | Symbol           | Value      | Unit          |
|---|------------------|------------|---------------|
| Drain-Source Voltage ( $V_{GS}=0V$ )              | $V_{DS}$         | 75         | V             |
| Gate-Source Voltage ( $V_{DS}=0V$ )               | $V_{GS}$         | $\pm 20$   | V             |
| Drain Current (DC) at $T_c=25^\circ C$            | $I_D$ (DC)       | 60         | A             |
| Drain Current (DC) at $T_c=100^\circ C$           | $I_D$ (DC)       | 42         | A             |
| Drain Current-Continuous@ Current-Pulsed (Note 1) | $I_{DM}$ (pulse) | 310        | A             |
| Peak diode recovery voltage                       | $dv/dt$          | 30         | V/ns          |
| Maximum Power Dissipation( $T_c=25^\circ C$ )     | $P_D$            | 140        | W             |
| Derating factor                                   |                  | 0.95       | W/ $^\circ C$ |
| Single pulse avalanche energy (Note 2)            | $E_{AS}$         | 300        | mJ            |
| Operating Junction and Storage Temperature Range  | $T_J, T_{STG}$   | -55 To 175 | $^\circ C$    |

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2.EAS condition:  $T_j=25^\circ C$ ,  $VDD=37.5V$ ,  $VG=10V$ ,  $L=0.5mH$

**Table 2. Thermal Characteristic**

| Parameter   | Symbol            | Value | Unit |
|---|-------------------|-------|------|
| Thermal Resistance, Junction-to-Case (Maximum)    | R <sub>thJC</sub> | 1.05  | °C/W |
| Thermal Resistance, Junction-to-Ambient (Maximum) | R <sub>thJA</sub> | 50    | °C/W |

**Table 3. Electrical Characteristics (T<sub>c</sub>=25°C unless otherwise noted)**

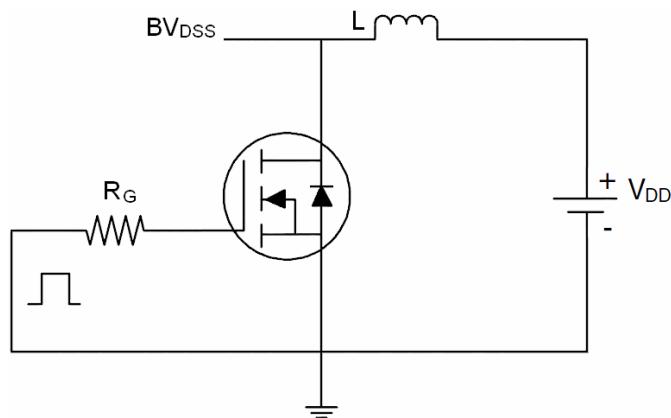
| Parameter  | Symbol              | Condition   | Min | Typ  | Max  | Unit |
|--|---------------------|---|-----|------|------|------|
| <b>On/off states</b>                                   |                     |   |     |      |      |      |
| Drain-Source Breakdown Voltage                         | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250μA   | 75  | 84   | -    | V    |
| Zero Gate Voltage Drain Current(T <sub>c</sub> =25°C)  | I <sub>DSS</sub>    | V <sub>DS</sub> =75V, V <sub>GS</sub> =0V   | -   | -    | 1    | μA   |
| Zero Gate Voltage Drain Current(T <sub>c</sub> =125°C) | I <sub>DSS</sub>    | V <sub>DS</sub> =75V, V <sub>GS</sub> =0V   | -   | -    | 10   | μA   |
| Gate-Body Leakage Current                              | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V  | -   | -    | ±100 | nA   |
| Gate Threshold Voltage                                 | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA  | 2   | 3    | 4    | V    |
| Drain-Source On-State Resistance                       | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =30A   | -   | 6.8  | 8.5  | mΩ   |
| <b>Dynamic Characteristics</b>                         |                     |   |     |      |      |      |
| Forward Transconductance                               | g <sub>FS</sub>     | V <sub>DS</sub> =5V, I <sub>D</sub> =30A  |     | 66   | -    | S    |
| Input Capacitance                                      | C <sub>iss</sub>    | V <sub>DS</sub> =25V, V <sub>GS</sub> =0V,<br>F=1.0MHz  |     | 4400 | -    | PF   |
| Output Capacitance                                     | C <sub>oss</sub>    |   |     | 340  | -    | PF   |
| Reverse Transfer Capacitance                           | C <sub>rss</sub>    |   |     | 260  | -    | PF   |
| Total Gate Charge                                      | Q <sub>g</sub>      | V <sub>DS</sub> =30V, I <sub>D</sub> =30A,<br>V <sub>GS</sub> =10V  |     | 100  | -    | nC   |
| Gate-Source Charge                                     | Q <sub>gs</sub>     |   |     | 20   | -    | nC   |
| Gate-Drain Charge                                      | Q <sub>gd</sub>     |   |     | 30   | -    | nC   |
| <b>Switching times</b>                                 |                     |   |     |      |      |      |
| Turn-on Delay Time                                     | t <sub>d(on)</sub>  | V <sub>DD</sub> =30V, I <sub>D</sub> =2A, R <sub>L</sub> =15Ω<br>V <sub>GS</sub> =10V, R <sub>G</sub> =2.5Ω | -   | 17.8 | -    | nS   |
| Turn-on Rise Time                                      | t <sub>r</sub>      |   | -   | 11.8 | -    | nS   |
| Turn-Off Delay Time                                    | t <sub>d(off)</sub> |   | -   | 56   | -    | nS   |
| Turn-Off Fall Time                                     | t <sub>f</sub>      |   | -   | 14.6 | -    | nS   |
| <b>Source- Drain Diode Characteristics</b>             |                     |   |     |      |      |      |
| Source-drain current(Body Diode)                       | I <sub>SD</sub>     |   | -   | -    | 80   | A    |
| Pulsed Source-drain current(Body Diode)                | I <sub>SDM</sub>    |   | -   | -    | 320  | A    |
| Forward on voltage <sup>(Note 1)</sup>                 | V <sub>SD</sub>     | T <sub>j</sub> =25°C, I <sub>SD</sub> =30A, V <sub>GS</sub> =0V   | -   | -    | 1.2  | V    |
| Reverse Recovery Time <sup>(Note 1)</sup>              | t <sub>rr</sub>     | T <sub>j</sub> =25°C, I <sub>F</sub> =75A, di/dt=100A/μs  | -   | -    | 36   | nS   |
| Reverse Recovery Charge <sup>(Note 1)</sup>            | Q <sub>rr</sub>     |   | -   | -    | 56   | nC   |
| Forward Turn-on Time                                   | t <sub>on</sub>     | Intrinsic turn-on time is negligible(turn-on is dominated by L <sub>S</sub> +L <sub>D</sub> )               |     |      |      |      |

#### Notes

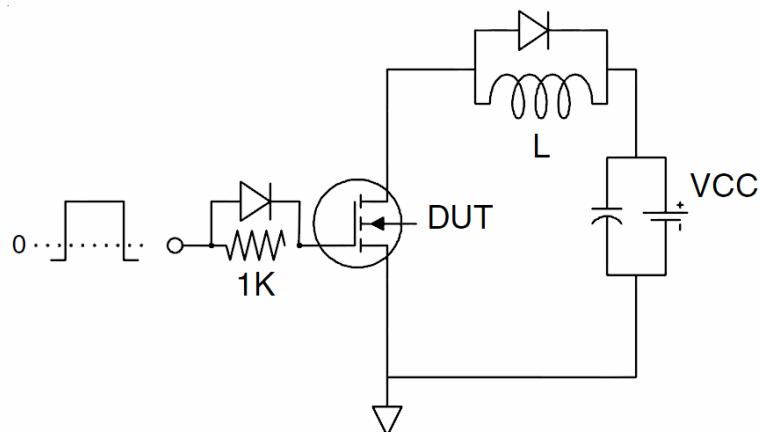
1.Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 1.5%, R<sub>G</sub>=25Ω, Starting T<sub>j</sub>=25°C

## Test Circuit

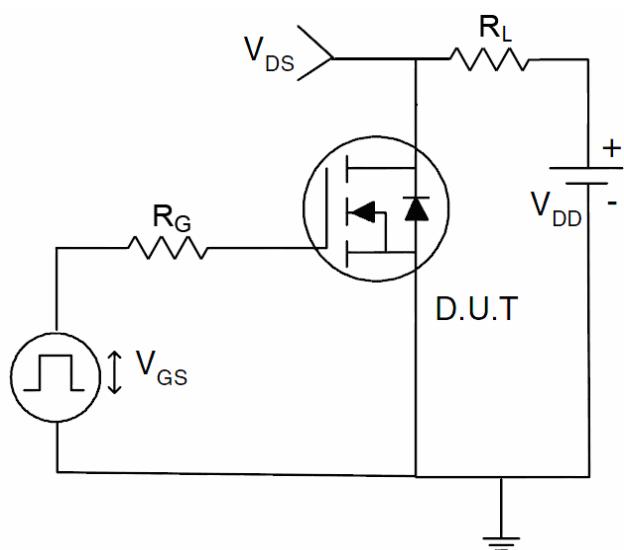
### 1) E<sub>AS</sub> test circuit



### 2) Gate charge test circuit



### 3) Switch Time Test Circuit



### Typical Electrical and Thermal Characteristics (curves)

Figure1. Safe operating area

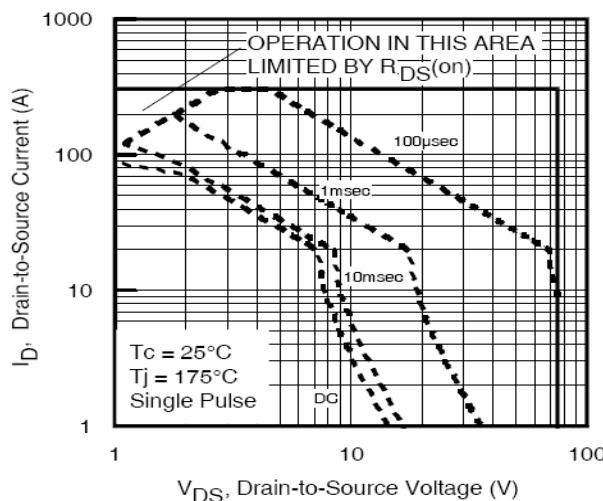


Figure2. Source-Drain Diode Forward Voltage

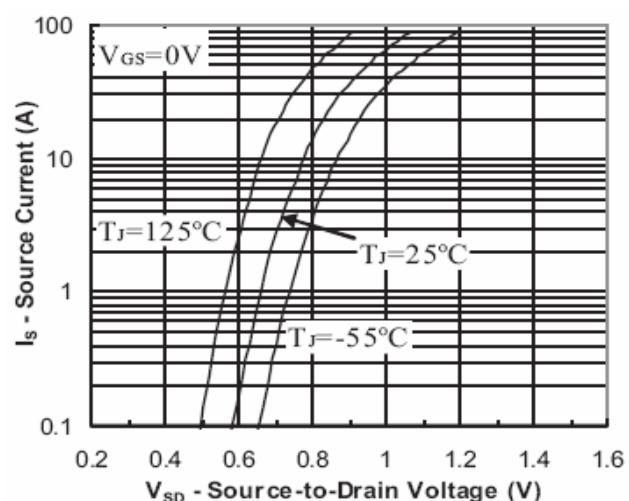


Figure3. Output characteristics

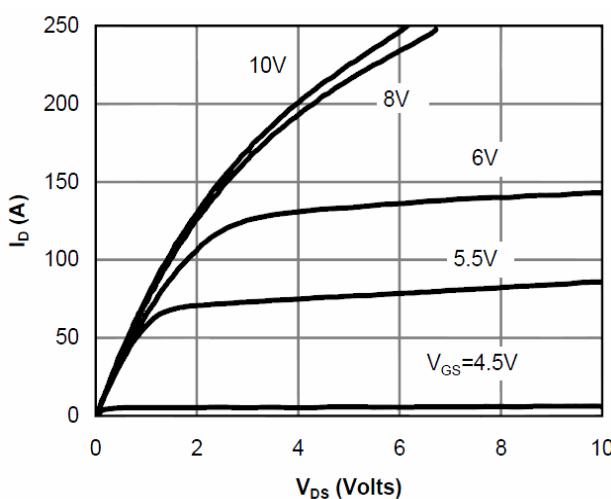


Figure4. Transfer characteristics

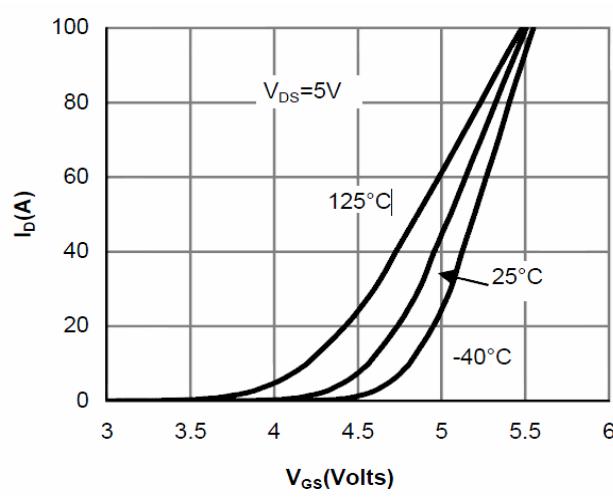


Figure5. Static drain-source on resistance

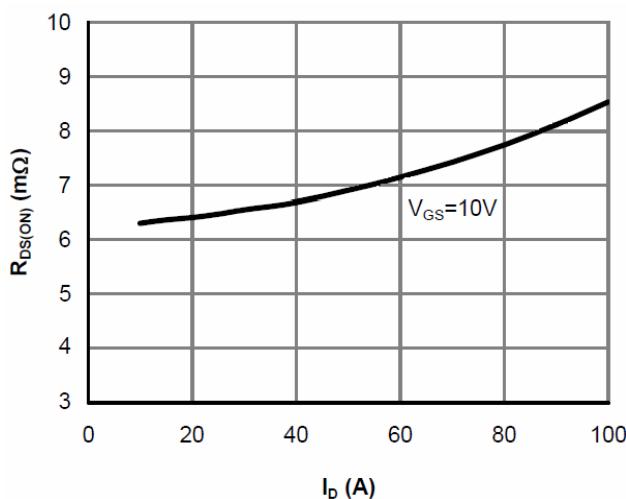


Figure6.  $R_{DS(ON)}$  vs Junction Temperature

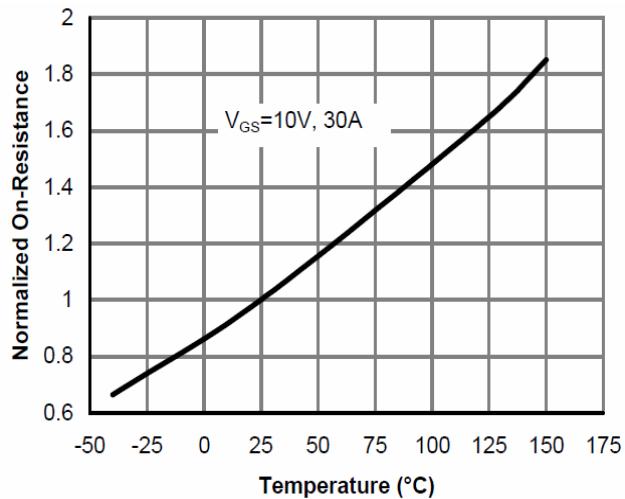


Figure7.  $BV_{DSS}$  vs Junction Temperature

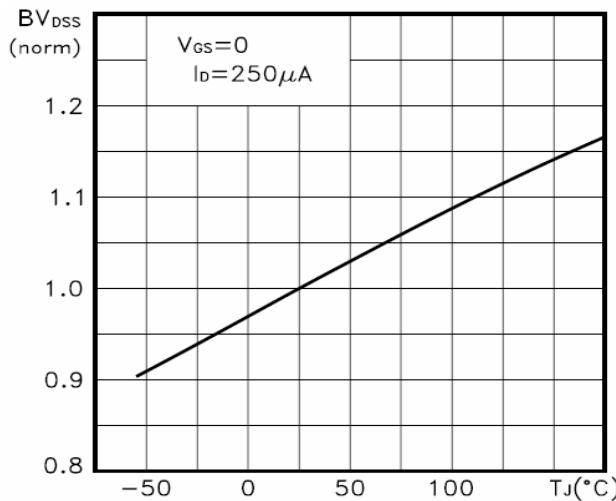


Figure8.  $V_{GS(th)}$  vs Junction Temperature

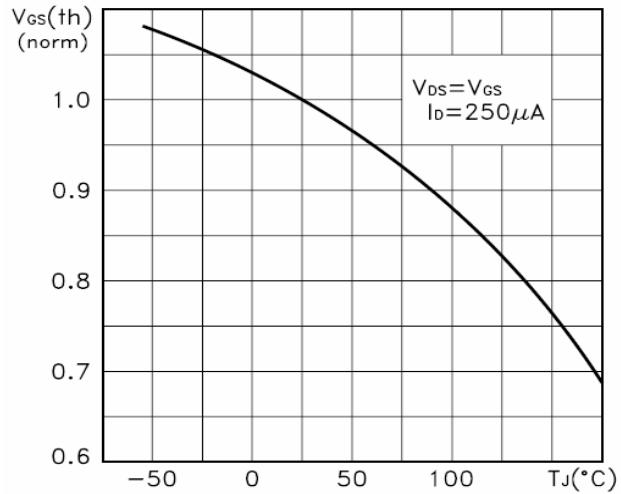


Figure9. Gate charge waveforms

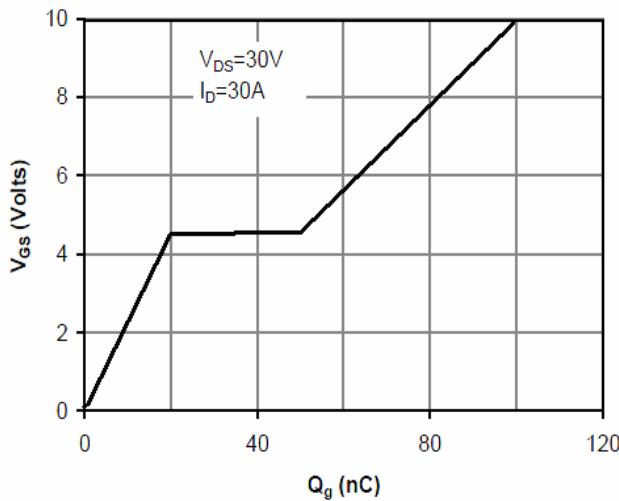


Figure10. Capacitance

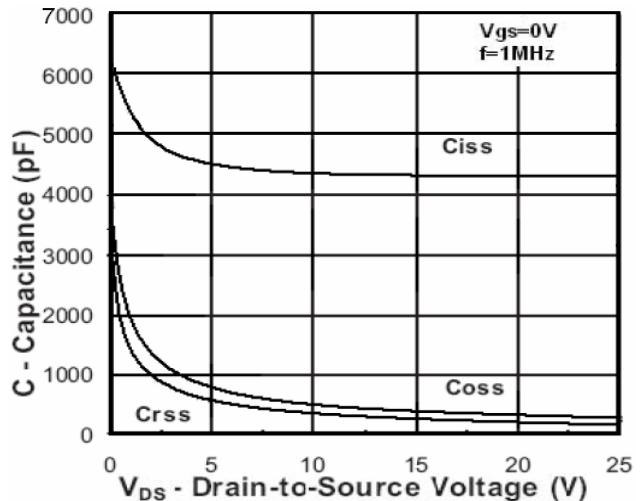
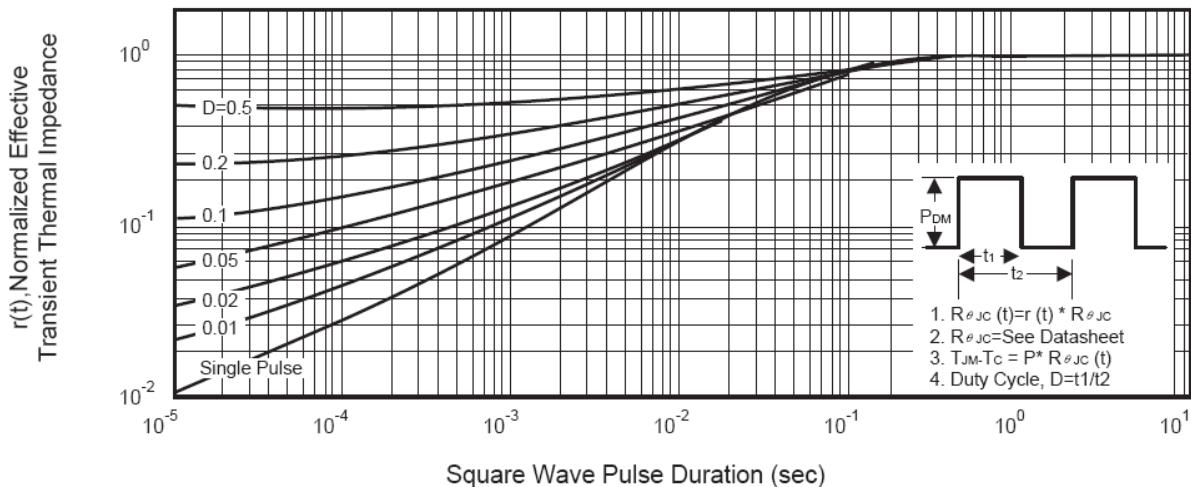
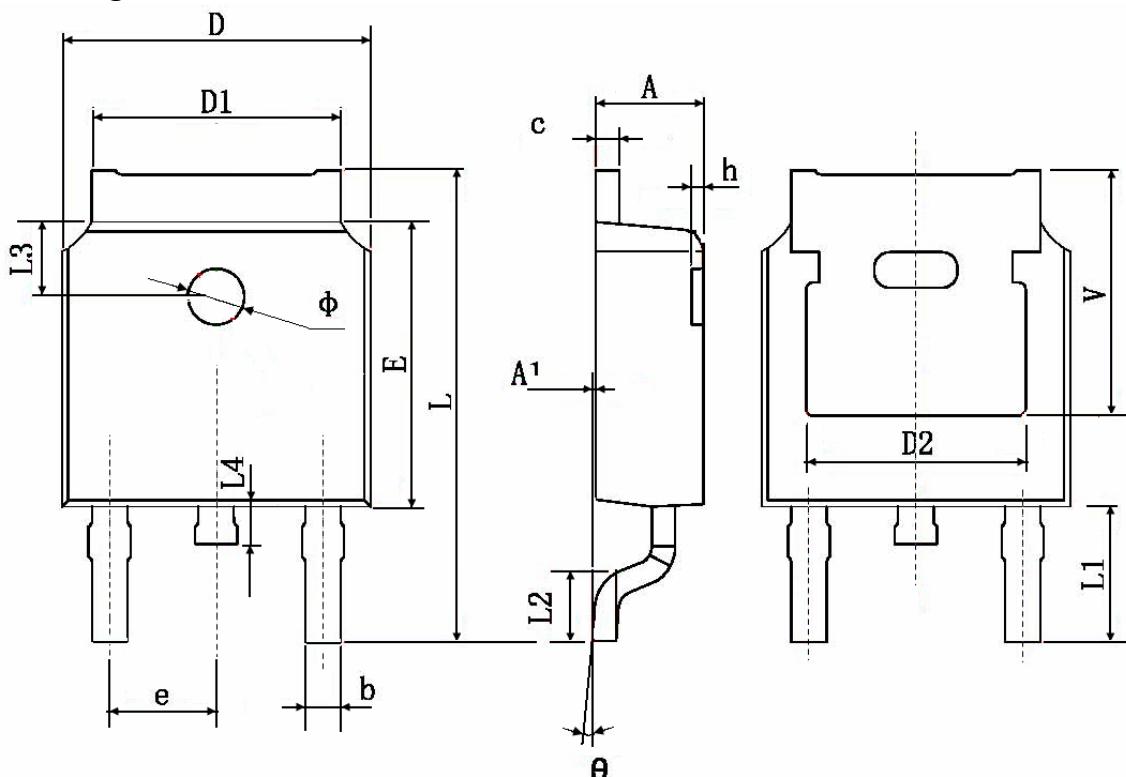


Figure11. Normalized Maximum Transient Thermal Impedance



### TO-252 Package Information



| Symbol   | Dimensions In Millimeters |        | Dimensions In Inches |       |
|----------|---------------------------|--------|----------------------|-------|
|          | Min.                      | Max.   | Min.                 | Max.  |
| A        | 2.200                     | 2.400  | 0.087                | 0.094 |
| A1       | 0.000                     | 0.127  | 0.000                | 0.005 |
| b        | 0.660                     | 0.860  | 0.026                | 0.034 |
| c        | 0.460                     | 0.580  | 0.018                | 0.023 |
| D        | 6.500                     | 6.700  | 0.256                | 0.264 |
| D1       | 5.100                     | 5.460  | 0.201                | 0.215 |
| D2       | 0.483 TYP.                |        | 0.190 TYP.           |       |
| E        | 6.000                     | 6.200  | 0.236                | 0.244 |
| e        | 2.186                     | 2.386  | 0.086                | 0.094 |
| L        | 9.800                     | 10.400 | 0.386                | 0.409 |
| L1       | 2.900 TYP.                |        | 0.114 TYP.           |       |
| L2       | 1.400                     | 1.700  | 0.055                | 0.067 |
| L3       | 1.600 TYP.                |        | 0.063 TYP.           |       |
| L4       | 0.600                     | 1.000  | 0.024                | 0.039 |
| $\Phi$   | 1.100                     | 1.300  | 0.043                | 0.051 |
| $\theta$ | 0°                        | 8°     | 0°                   | 8°    |
| h        | 0.000                     | 0.300  | 0.000                | 0.012 |
| V        | 5.350 TYP.                |        | 0.211 TYP.           |       |